

SN54ALS243A, SN74ALS243A QUADRUPLE BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

SDAS069B – DECEMBER 1982 – REVISED DECEMBER 1994

- Two-Way Asynchronous Communication Between Data Buses
- pnp Inputs Reduce dc Loading
- Package Options Include Plastic Small-Outline (D) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

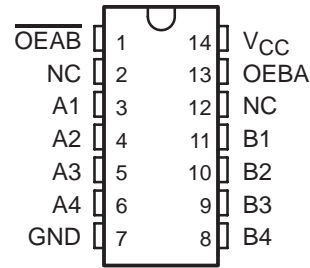
description

These quadruple bus transceivers are designed for asynchronous two-way communication between data buses. The control-function implementation allows for maximum flexibility in timing. These devices allow data transmission from the A bus to the B bus or from the B bus to the A bus depending upon the logic levels at the output-enable (OEBA and $\overline{\text{OEAB}}$) inputs. The output-enable inputs can be used to disable the device so that the buses are effectively isolated.

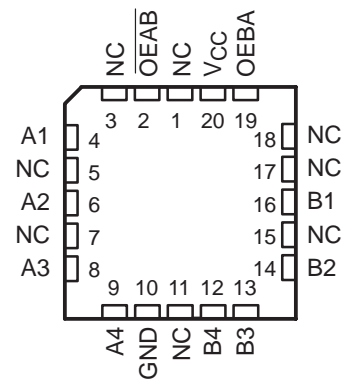
The dual-enable configuration gives the quadruple bus transceivers the capability to store data by simultaneously enabling OEBA and $\overline{\text{OEAB}}$. Each output reinforces its input in this transceiver configuration. When both control inputs are enabled and all other data sources to the two sets of bus lines are at high impedance, both sets of bus lines (eight in all) retain their states. The 4-bit codes appearing on the two sets of buses are identical.

The SN54ALS243A is characterized for operation over the full military temperature range of -55°C to 125°C . The SN74ALS243A is characterized for operation from 0°C to 70°C .

SN54ALS243A . . . J PACKAGE
SN74ALS243A . . . D OR N PACKAGE
(TOP VIEW)



SN54ALS243A . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

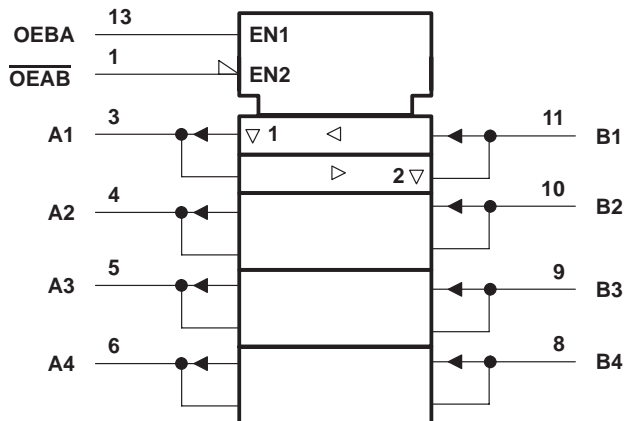
FUNCTION TABLE

| INPUTS | | FUNCTION |
|--------------------------|------|--------------------------|
| $\overline{\text{OEAB}}$ | OEBA | |
| L | L | A to B |
| H | H | B to A |
| H | L | Isolation |
| L | H | Latch A and B (A = B) |

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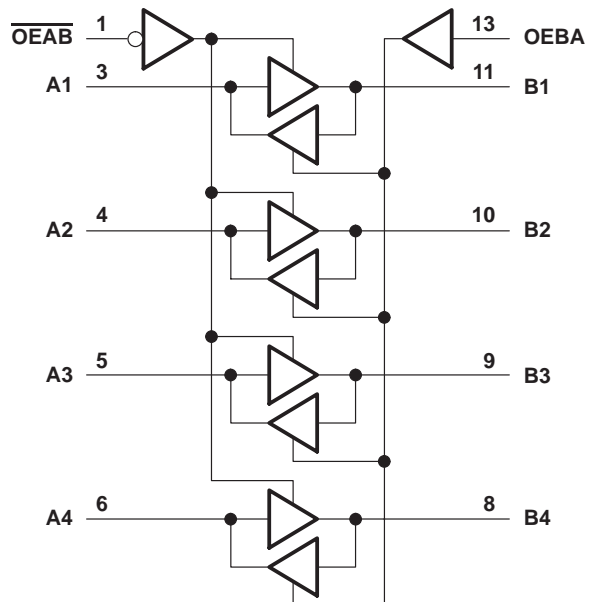
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logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.
Pin numbers shown are for the D, J, and N packages.

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

| | |
|---|----------------|
| Supply voltage, V_{CC} | 7 V |
| Input voltage, V_I : All inputs | 7 V |
| I/O ports | 5.5 V |
| Operating free-air temperature range, T_A : SN54ALS243A | -55°C to 125°C |
| SN74ALS243A | 0°C to 70°C |
| Storage temperature range | -65°C to 150°C |

‡ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

| | SN54ALS243A | | | SN74ALS243A | | | UNIT |
|--------------------------------------|-------------|-----|-----|-------------|-----|-----|------|
| | MIN | NOM | MAX | MIN | NOM | MAX | |
| V_{CC} Supply voltage | 4.5 | 5 | 5.5 | 4.5 | 5 | 5.5 | V |
| V_{IH} High-level input voltage | 2 | | | 2 | | | V |
| V_{IL} Low-level input voltage | | | 0.7 | | | 0.8 | V |
| I_{OH} High-level output current | | | -12 | | | -15 | mA |
| I_{OL} Low-level output current | | | 12 | | | 24 | mA |
| T_A Operating free-air temperature | -55 | | 125 | 0 | | 70 | °C |

SN54ALS243A, SN74ALS243A QUADRUPLE BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | SN54ALS243A | | SN74ALS243A | | UNIT | |
|-----------|---|---|----------------------|--------------|------|------|---------------|
| | | MIN | TYP† | MAX | MIN | | TYP† |
| V_{IK} | $V_{CC} = 4.5\text{ V}$, $I_I = -18\text{ mA}$ | | | -1.2 | | -1.2 | V |
| V_{OH} | $V_{CC} = 4.5\text{ V to }5.5\text{ V}$, $I_{OH} = -0.4\text{ mA}$ | $V_{CC} - 2$ | | $V_{CC} - 2$ | | V | |
| | $V_{CC} = 4.5\text{ V}$, $I_{OH} = -3\text{ mA}$ | 2.4 | 3.2 | 2.4 | 3.2 | | |
| | $V_{CC} = 4.5\text{ V}$, $I_{OH} = -12\text{ mA}$ $I_{OH} = -15\text{ mA}$ | 2 | | 2 | | | |
| V_{OL} | $V_{CC} = 4.5\text{ V}$ | $I_{OL} = 12\text{ mA}$ | 0.25 | 0.4 | 0.25 | 0.4 | V |
| | | $I_{OL} = 24\text{ mA}$ | | | 0.35 | 0.5 | |
| I_I | Control inputs | $V_{CC} = 5.5\text{ V}$ | $V_I = 7\text{ V}$ | | 0.1 | 0.1 | mA |
| | A or B ports | | $V_I = 5.5\text{ V}$ | | 0.1 | 0.1 | |
| I_{IH} | Control inputs | $V_{CC} = 5.5\text{ V}$, $V_I = 2.7\text{ V}$ | | 20 | | 20 | μA |
| | A or B ports‡ | | | 20 | | 20 | |
| I_{IL} | Control inputs | $V_{CC} = 5.5\text{ V}$, $V_I = 0.4\text{ V}$ | | -0.1 | | -0.1 | mA |
| | A or B ports‡ | | | -0.1 | | -0.1 | |
| I_O § | $V_{CC} = 5.5\text{ V}$, $V_O = 2.25\text{ V}$ | | -20 | -112 | -30 | -112 | mA |
| I_{CC} | $V_{CC} = 5.5\text{ V}$ | Outputs high | 15 | 30 | 15 | 25 | mA |
| | | Outputs low | 20 | 35 | 20 | 30 | |
| | | Outputs disabled | 21 | 37 | 21 | 32 | |

† All typical values are at $V_{CC} = 5\text{ V}$, $T_A = 25^\circ\text{C}$.

‡ For I/O ports, the parameters I_{IH} and I_{IL} include the off-state output current.

§ The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, I_{OS} .

switching characteristics (see Figure 1)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | $V_{CC} = 4.5\text{ V to }5.5\text{ V}$, $C_L = 50\text{ pF}$, $R_1 = 500\ \Omega$, $R_2 = 500\ \Omega$, $T_A = \text{MIN to MAX}\ddagger$ | | | | UNIT |
|-----------|--------------------------|-------------|--|-----|-------------|-----|------|
| | | | SN54ALS243A | | SN74ALS243A | | |
| | | | MIN | MAX | MIN | MAX | |
| t_{PLH} | A or B | B or A | 4 | 15 | 4 | 11 | ns |
| t_{PHL} | | | 4 | 15 | 4 | 11 | |
| t_{PZH} | $\overline{\text{OEAB}}$ | B | 7 | 25 | 7 | 20 | ns |
| t_{PZL} | | | 7 | 25 | 7 | 20 | |
| t_{PHZ} | $\overline{\text{OEAB}}$ | B | 2 | 16 | 2 | 14 | ns |
| t_{PLZ} | | | 3 | 27 | 3 | 22 | |
| t_{PZH} | OEBA | A | 7 | 25 | 7 | 20 | ns |
| t_{PZL} | | | 7 | 25 | 7 | 20 | |
| t_{PHZ} | OEBA | A | 2 | 16 | 2 | 14 | ns |
| t_{PLZ} | | | 3 | 27 | 3 | 22 | |

†† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



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PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES





- NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
 D. All input pulses have the following characteristics: $PRR \leq 1$ MHz, $t_r = t_f = 2$ ns, duty cycle = 50%.
 E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms



PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead/Ball Finish (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|-----------------|------|-------------|-----------------|-------------------------|----------------------|--------------|---------------------------------|---|
| 84013022A | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type | -55 to 125 | 84013022A SNJ54ALS 243AFK |  |
| SNJ54ALS243AFK | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type | -55 to 125 | 84013022A SNJ54ALS 243AFK |  |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSELETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



| NO. OF TERMINALS ** | A | | B | |
|---------------------|------------------|------------------|------------------|------------------|
| | MIN | MAX | MIN | MAX |
| 20 | 0.342 (8,69) | 0.358 (9,09) | 0.307 (7,80) | 0.358 (9,09) |
| 28 | 0.442 (11,23) | 0.458 (11,63) | 0.406 (10,31) | 0.458 (11,63) |
| 44 | 0.640 (16,26) | 0.660 (16,76) | 0.495 (12,58) | 0.560 (14,22) |
| 52 | 0.740 (18,78) | 0.761 (19,32) | 0.495 (12,58) | 0.560 (14,22) |
| 68 | 0.938 (23,83) | 0.962 (24,43) | 0.850 (21,6) | 0.858 (21,8) |
| 84 | 1.141 (28,99) | 1.165 (29,59) | 1.047 (26,6) | 1.063 (27,0) |



4040140/D 01/11

- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - This package can be hermetically sealed with a metal lid.
 - Falls within JEDEC MS-004

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